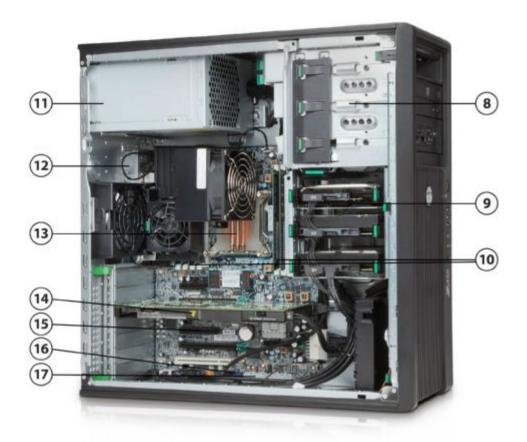
#### Overview



- 1. Handle in Top Optical Bay (optional)
- 2. 3 External 5.25" Bays
- 3. 22-in-1 Media Card Reader (optional)
- 4. Power Button
- 5. HDD Activity LED
- 6. Front I/O: 1 USB 2.0, 2 USB 3.0, 1 Headphone, 1 Microphone, 1 1394a
- 7. Easy-open Side Panel



#### Overview



- 8. 3 External 5.25" Bays
- 9. 3 Internal 3.5" Bays
- 10. 8 DIMM Slots for DDR3 ECC Memory
- 11. 600W, 90% Efficient Power Supply
- 12. Rear I/O: Rear Power Button & LED, PS/2 Ports, 1 1394a, 4 USB 2.0, 2 USB 3.0, 1 RJ-45 to Integrated GbE, 1 Audio Line In, 1 Audio Line Out, 1 Microphone
- 13. Intel Xeon Processors E5-1600 family (4C/6C) or E5-2600 family (8C)
- 14. 2 PCle x16 Gen3 Slots
- 15. 1 PCle x8 Gen3, 1 PCle x8(x4) Gen2, 1 PCle x4(x1) Gen2, 1 PCl Slot
- 16. 6 Internal USB 2.0 Ports
- 17. 10 SATA Ports

Form Factor	Convertible Minitower
Operating Systems	Preinstalled:
	<ul> <li>Genuine Windows® 7 Ultimate 64-Bit*</li> <li>Genuine Windows® 7 Professional 32-Bit*</li> <li>Genuine Windows® 7 Professional 64-Bit*</li> <li>HP Installer Kit for Linux (includes drivers for 64-bit OS versions of RHEL 5 &amp; 6 and SUSE Linux Enterprise Desktop 11)</li> <li>SUSE Linux Enterprise Desktop 11</li> <li>Red Hat Enterprise Linux Desktop (Preinstall NOT available; 1 year paper license only)</li> </ul>



#### Overview

#### Supported:

Genuine Windows® 7 Enterprise 32/64

Notes: \* Systems may require upgraded and/or separately purchased hardware and/or a DVD drive to install the Windows 7 software and take full advantage of Windows 7 functionality. See <a href="http://www.microsoft.com/windows/windows-7/">http://www.microsoft.com/windows/windows-7/</a> for details.

Notes: For detailed OS/hardware support information for Linux, see:

http://www.hp.com/support/linux\_hardware\_matrix

#### Available Processors

Name	Cores	Clock Speed (GHz)	Cache (MB)	Memory Speed (MHz)	QPI Speed (GT/s)	Hyper- Threading	Featuring Intel® vPro™ Tech- nology	Intel® Turbo Boost Tech- nology <sup>1</sup>	TD (W
Intel® Xeon® E5-2687W processor	8	3.1	20	1600	8.0	Y	Y	3, 7	15
Intel Xeon E5-2665 processor	8	2.4	20	1600	8.0	Y	Y	4, 7	11
Intel Xeon E5-1660 processor	6	3.3	15	1600	-	Y	Y	3, 6	13
Intel Xeon E5-1650 processor	6	3.2	12	1600	-	Y	Y	3, 6	13
Intel Xeon E5-1620 processor	4	3.6	10	1600	-	Y	Y	2, 3	13
Intel Xeon E5-1607 processor	4	3.0	10	1066	-	N	Y	N/A	13
Intel Xeon E5-1603 processor	4	2.8	10	1066	-	N	Y	N/A	13

<sup>1</sup>The specifications shown in this column represent the following: (all core maximum turbo steps, one core maximum turbo steps). Turbo boost stepping occurs in 100MHz increments. Processor that do not have turbo functionality are denoted as N/A.

**NOTE**: Although the Intel Xeon E5-2600 processor family supports dual processors, the HP Z420 Workstation does not support dual processor configurations.

#### Available Processor Disclaimers

Intel's numbering is not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor\_number/ for details.

64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipsel BIOS, operating system, device drivers and applications enabled for Intel 64 architecture. Processor will not operate (including 32-bit operation) without an Intel 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information.

Quad-Core, Six-Core, and Eight-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits. Check with software provider to determine suitability. Not all customers or software applications will necessarily benefit from use these technologies.

Color

Jack Black

Convertibility

Yes. 5.25" drives rotate for Minitower or Desktop orientation.



#### Overview

010/1/01/		
	Slot 1 (top):	
1 *	PCI Express Gen2 x4(1)*	
more details)	Full-height, Full-length	
	Slot 2:	
	PCI Express Gen3 x 16	
	Full-height, Full-length (with	n extender)
		,
	Slot 3:	
		with open-ended connector**
	Full-height, Full-length (with	n extender)
	Slot 4:	
	PCI Express Gen3 x8 with	open-ended connector**
	Full-height, Full-length (with	n extender)
	Olat E.	
	Slot 5: PCI Express Gen3 x16	
	Full-height, Full-length (with	n extender)
	i dii-neight, i dii-length (with	i exterior y
	Slot 6:	
	PCI 32bit/33MHz	
	Full-height, Full-length (with	n extender)
	* x <number> = number of</number>	anes or size of the physical/mechanical connector.
		s supported electrically. Typically communicated as x# mechanical,
	x(#)electrical.	
		llows a greater bandwidth (e.g. x16) card to be installed physically into
Evnencion Pava (coo	lower bandwidth connector	
<b>Expansion Bays</b> (see storage section for more	3 external 5.25" bays	coustic dampening rail assemblies pre-installed)
details)	(4th HDD occupies one ext	ernal bav)
,		
	Top and Middle 5.25" bay	device depth limit: 206mm (8.11 inches)
	Bottom 5 25" hav device de	epth limit: 173mm (6.81 inches)
Front I/O	:	EEE 1394a standard, 1 Headphone,1 Microphone
Internal I/O	i e	by three separate 2x5 headers: each header supports either a HP
	·	BB Media Card Reader, one on each header. Each Internal Port Kit ha
	two USB 2.0 connectors.	·
Rear I/O	2 USB 3.0, 4 USB 2.0,1 IE	EE 1394a port, 2 PS/2, RJ-45 (NIC), 1 Audio Line-In, 1 Audio Line-Ou
	1 Microphone.	
	1	nal connector on PCI bracket cabled to system board connector
Interfaces Supported	22-in-1 Media Card Reader	
		(2 @ 6.0 Gb/s, 8 @ 3.0 Gb/s). 6 channels are eSATA configurable (2 use with eSATA CTO/AMO Kit.
	USB 2.0, USB 3.0, IEEE 1	
On-board RAID Suppor		oo la mondoo
Chassis Dimensions	i	ution: 44.76 x 17.78 x 44.52 cm (17.6 x 7.0 x 17.5 in)
(HxWxD)		tion: 17.9 x 44.76 x 44.52 cm (7.0 x 17.6 x 17.5 in)
Weight	Exact weights depend upor	
	Minimum: 12.5kg (27.5 lbs	
	Standard: 13.2kg (29.2 lbs)	
	Maximum: 17.7kg (39 lbs)	
Temperature		5° to 35°C (40° to 95°F)
	Non-operating	-40° to 60°C (-40° to 140°F)



#### Overview

Humidity	Operating:	8% to 85% relative humidity, non-condensing	
	Non-operating	8% to 90% relative humidity, non-condensing	
Maximum Altitude (non-	Operating:	3,048m (10,000ft)	
pressurized)	Non-operating	9,144m (30,000ft)	
Power Supply	600 watts wide-ranging, active Power Factor Correction, 90% Efficient		
	The Z420 600W power sup	oply efficiency report can be found at this link: TBD	
Workstation ISV	See the latest list of certific	cations at	
Certifications	http://www.hp.com/united-	states/campaigns/workstations/partnerships.html	





#### Supported Components

Processors		Factory Configured	Option Kit	Option Kit Part Support Number Notes
	Intel Xeon E5-2600 Series - CTO			
	Intel® Xeon® Processor E5-2687W 8C 3.10GHz	Υ	N	See note 1
	Intel® Xeon® Processor E5-2665 8C 2.40GHz	Υ	N	
	Intel Xeon E5-1600 Series			
	Intel® Xeon® Processor E5-1660 6C 3.30GHz	Υ	N	
	Intel® Xeon® Processor E5-1650 6C 3.20GHz	Υ	Ν	
	Intel® Xeon® Processor E5-1650 6C 3.20GHz	Υ	N	
	Intel® Xeon® Processor E5-1620 4C 3.60GHz	Υ	N	
	Intel® Xeon® Processor E5-1607 4C 3.00GHz	Υ	N	
	Intel® Xeon® Processor E5-1603 4C 2.80GHz	Υ	N	
	NOTE 1: HP Liquid Cooling option available for all t	the above proce	essors. H	P Liquid Cooling

**NOTE 1**: HP Liquid Cooling option available for all the above processors. HP Liquid Cooling option is required on the E5-2687W processor model.

**NOTE 2**: Intel's numbering is not a measurement of higher performance.

#### **Hard Drives**

SAS Hard Drives		Factory Configured	Option Kit		Support Notes		
	HP SAS (Serial Attached SCSI) Hard Drives for	HP Workstati	ions				
	600GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	VM647AA			
	450GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	LU968AA			
	300GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	LU967AA			
	HP 300GB SAS 10K SFF HDD	Υ	Υ	A2Z20AA			
	HP 600GB SAS 10K SFF HDD	Υ	Υ	A2Z21AA			
	<b>Sub-Section Description/Notes</b>						
	Up to (4) 3.5-inch 15K rpm SAS drives: 300, 450, 6	600 GB; 2.4 TE	3 max				
	Up to (4) 2.5-inch 10K rpm SAS drives: 300, 600 GB; 2.4 TB max						
	NOTE: SAS controller add-in card required						
	<b>NOTE:</b> 4th SFF HDDs will be automatically installe carrier	d into the top	optical ba	ay in a Handle	e/HDD		
	Removable Boot Drive option						
SATA Hard Drives	SATA (Serial ATA) Hard Drives for HP Workstat	ions					
	250GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ034AA			
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ036AA			
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ037AA			
	2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QB576AA			
	3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QF298AA			
	Sub-Section Description/Notes						



#### Supported Components

Up to (4) 3.5-inch 7200 rpm SATA drives: 250, 500 GB, 1.0, 2.0, 3.0 TB; 11.0 TB max

NOTE: 3.0 TB drive not available as HDD1

Removable Boot Drive option

SATA Solid State Drives

**HP Solid State Drives (SSDs) for Workstations** 

 HP 300GB SATA SSD
 Y
 Y
 LZ069AA

 HP 160GB SATA SSD
 Y
 Y
 LZ704AA

 HP 256GB SATA SSD
 Y
 Y
 A3D26AA

 HP 128GB SATA SSD
 Y
 Y
 A3D25AA

Up to (4) 2.5-inch SATA Solid State Drives: 160, 300 GB: 1.2 TB max

NOTE: 128, 256 GB Solid State Drives only available as HDD1

NOTE: 4th SSDs will be automatically installed into the top optical bay in a Handle/HDD

carrier

For hard drives, 1 GB = 1 billion bytes; TB = 1 trillion bytes. Actual formatted capacity is less.

Hard Drive Controllers		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated SATA 6.0 Gb/s Controller				
	Integrated SATA 6.0 Gb/s Controller	Υ	N		Two ports
	Integrated SATA 3.0 Gb/s Controller				
	Integrated SATA 3.0 Gb/s Controller	Υ	N		Eight ports
	Factory integrated RAID on motherboar	d for SATA driv	es es		
	RAID 0 Configuration - Striped Array	Υ	N		See note 1
	RAID 0 Data Configuration Boot/OS Drive + 2 Drive Striped Array	Y	N		See note 1
	RAID 1 Configuration - Mirrored Array	Υ	N		See note 1
	RAID 10 Configuration - Striped/Mirrored Array	Y	N		See note 1
	LSI 9212 4-Port SAS 6Gb/s RAID Card				
	LSI 9212 4-Port SAS 6Gb/s RAID Card	Υ	Υ	XP310AA	See note 2

#### LSI MegaRAID® 9260-8i SAS 6Gb/s ROC RAID Card and iBBU08 Battery Backup Unit

LSI MegaRAID® 9260-8i SAS 6Gb/s ROC RAID Card	N	Υ	WE465AA	See note 2 and 3
Optional: LSI iBBU08 Battery Backup Unit	N	Υ	LA783AA	

TOT LSI 9260-81

SATA hardware RAID is not supported on Linux systems. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit

 $http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00060684/c00060684.pdf \ for \ RAID \ capabilities \ with \ Linux.$ 

All drives must be identical in type and capacity

All RAID arrays must be less than 2 TB

**NOTE 1**: Requires hard drives with identical speed, capacity, and interface. Specific user-configured hardware SAS RAID configurations are supported on this Linux system. Please visit: http://www.hp.com/support/linux\_hardware\_matrix for details.



#### Supported Components

**NOTE 2:** Specific user-configured hardware SAS RAID configurations are supported on this Linux system. Please visit: http://www.hp.com/support/linux\_hardware\_matrix for details.

NOTE 3: Not supported when HD drive 1 is SATA

Graphics		Factory Configured	Option Kit	Option Kit Part Number	Support Notes	Support Multi Mixed
	Professional 2D					
	AMD FirePro 2270 512MB Graphics Card	Y	Y	LA524AA	See note 1	3
	NVIDIA NVS300 512MB PCIe Graphics Card	Y	Y	XP612AA	See note 1	3
	NVIDIA NVS 310 512MB Graphics Card	Y	Υ	A7U59AA		3
	NVIDIA Quadro NVS 450 512 MB PCIe Graphics Card	Y	Y	FH519AA	See note 2	2
	Entry 3D					
	NVIDIA Quadro 410 512MB Graphics	Υ	Υ	A7U60AA		2
	NVIDIA Quadro 600 1GB Graphics Card	Y	Υ	WS093AA		2
	AMD FirePro V3900 1GB Graphics Card	Y	Y	A6R69AA		2
	AMD FirePro V4900 1GB Graphics Card	Y	Υ	A3J92AA		2
	Mid-range 3D					
	NVIDIA Quadro 2000 1GB Graphics Card	Y	Y	WS094AA		2
	AMD FirePro V5900 2GB Graphics	Υ	Υ	LS992AA		2
	High End 3D					
	AMD FirePro V7900 2GB Graphics	Υ	Υ	LS993AA		1
	NVIDIA Quadro 4000 2GB Graphics Card	Υ	Y	WS095AA		1
	NVIDIA Quadro 5000 2.5GB Graphics Card	Y	Υ	WS096AA		1
	NVIDIA Quadro 6000 6GB Graphics Card	N	Y	WS097AA	Available July 2012	1

**NOTE 1**: For thermal reasons, when configuring a 3rd NVS 300 or NVS 310 as an After Market Option, customers must also install the Fan and Front Card Guide Kit (A2Z46AA).

NOTE 2: If 1st graphics card is NVS 450 then 2nd graphics card must be NVS 450 or NVS 310.

High	Performance
GPU	Computing

	Factory Configured	• • • • • • • • • • • • • • • • • • • •		Support Notes	
NVIDIA Tesla C2075 Compute Processor	Υ	Υ	QB035AA	See note 1	

**NOTE 1:** Tesla C2075 does not have an operational graphics output and is only supported on this platform in combination with NVIDIA Quadro 410 1st graphics or NVIDIA Quadro 600 graphics.



Ontion

#### Supported Components

### Memory CTO Option Kit Part Support Notes Number

#### DDR3-1600 ECC Unbuffered DIMMs - CTO

8GB DDR3-1600 ECC Unbuffered RAM 4GB DDR3-1600 ECC Unbuffered RAM 2GB DDR3-1600 ECC Unbuffered RAM

#### **Sub-Section Description/Notes**

For details on the supported memory configurations on the HP Z420 Workstation, please refer to the System Technical Specifications - System Board section of this document.

DIMMs should be distributed across all four memory channels for optimal performance. Each processor supports up to 4 channels of DDR3 memory. To realize full performance at least 1 DIMM must be inserted into each channel.

The CPUs determine the speed at which the memory is clocked. If a 1066MHz capable CPU is used in the system, the maximum speed the memory will run at is 1066MHz regardless of the specified speed of the memory.

#### **AMO**

#### DDR3-1600 ECC Unbuffered DIMMs - AMO

 HP 8GB (1x8GB) DDR3-1600 ECC RAM
 A2Z50AA

 HP 4GB (1x4GB) DDR3-1600 ECC RAM
 A2Z48AA

 HP 2GB (1x2GB) DDR3-1600 ECC RAM
 A2Z47AA

**NOTE:** Only unbuffered DDR3 DIMMs are supported.

Multimedia and Audi	0			Option	
Devices		•	•	Kit Part	
		Configured	Kit	Number	Notes
	Integrated Intel/Realtek HD ALC262 Audio	Υ	N		
	HP Thin USB Powered Speakers	Υ	Υ	KK912AA	

Optical and Removable Storage		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP 16X DVD-ROM SATA Drive (non Lightscribe)	Y	Υ	AR629AA	See note 1
	HP 16X DVD+/-RW SuperMulti SATA Drive (non-Lightscribe)	Y	Υ	QS208AA	
	HP Blu-ray Writer	Υ	Υ	AR482AA	See note 2
	HP 22-in-1 Media Card Reader Kit (Workstations)	Y	Υ	NK361AA	

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.



#### Supported Components

**NOTE 1:** Not supported as a 2nd drive option.

**NOTE 2:** Cannot be ordered in combination with another Blu-ray Writer.

Controller Cards		Factory Configured	•	Option Kit Part Number	• •
	HP IEEE 1394b FireWire PCle Card	Y	Υ	NK653AA	

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated Intel 82579LM PCIe GbE Controller	Υ	N		
	Intel Gigabit CT Desktop NIC	N	Υ	FH969AA	See note 1
	Broadcom NetXtreme Gigabit Ethernet Plus NIC (PCIe)	Υ	Υ	FS215AA	See notes 1 and 2
	HP NC360T PCI Express Dual Port Gigabit NIC	N	Υ	KU004AA	See note 1
	HP Wireless NIC 802.11b/g/n PCle Card	N	Υ	FH971AA	
	NOTE A BOY DONE OF COMPANY			000016	0: 1::

**NOTE 1**: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required. **NOTE 2**: This is a PCI Express card based on the Broadcom 5761 chip. This card does not support DASH 1.1 manageability on this platform.

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Solenoid Hood Lock & Hood Sensor	Υ	Υ	DE618A	
	HP Business PC Security Lock Kit	N	Υ	PV606AA	
	HP xw4/Z2/Z4 Depth Adjustable Fixed Rail Rack Kit	N	Y	WH340AA	

Input Devices		Factory Configured	Option Kit	Option Kit Part Support Number Notes
	HP PS/2 Standard Keyboard	Y	Υ	DT527A
	HP USB Standard Keyboard	Y	Υ	DT528A
	HP PS/2 Optical Scroll Mouse	Υ	Υ	EY703AA
	HP USB 2-Button Optical Scroll Mouse	Υ	Υ	DC172B
	HP USB Laser Mouse	Υ	Υ	GW405AA
	HP USB Optical 3-Button Mouse	Υ	Υ	DY651A
	HP USB Smart Card Keyboard	N	Υ	ED707AA
	HP 2.4GHz Wireless Keyboard & Mouse	N	Υ	NB896AA
	HP USB Optical 3-Button 2.9M OEM Mouse	N	Υ	ET424AA
	HP SpaceExplorer 3D USB Controller	N	Υ	RY429AA
	HP SpacePilot 3D USB Intelligent Controller	N	Υ	WH343AA



#### Supported Components

Other Hardware		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Z420 Handle in Top Optical Bay	Υ	Υ	A9A48AA	See note 1
	HP Z4 Fan and Front Card Guide Kit	Υ	Υ	A2Z46AA	
	HP Serial Port Adapter	Υ	Υ	PA716A	
	HP eSATA PCI Cable Kit	Υ	Υ	GM110AA	
	HP Internal USB Port Kit	N	Υ	EM165AA	
	HP Optical Bay HDD Mounting Bracket	N	Υ	NQ099AA	
	HP Power Cord Kit	N	Υ	DM293A	
	Configure minitower in desktop orientation	Υ	Ν		
	HP Workstation Mouse Pad	Y	N		Japan only
	HP Energy Star Enabled Configuration	Υ	N		

**NOTE 1:** The HP Z420 Handle in Top Optical Bay kit, which contains two SFF internal drive bays, is installed automatically when customers order a 4th SFF hard drive.

Software		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Performance Advisor	Υ	Υ		See note 1
	HP Remote Graphics Software (RGS) V5	Υ	N		See note 2
	HP ProtectTools Security	Υ	N		See note 3
	MS Office Home & Business 2010	Υ	N		See note 4
	HP Power Assistant	Υ	N		
	Roxio Easy Media Creator (DVD/Blu-ray Disc burner software)	Υ	N		
	Intervideo WinDVD (DVD player/burner software)	Υ	N		
	PDF Complete - Trial Edition	Υ	N		
	NOTE 1: Available as a free download here: www.	hn com/go/ner	formance	advisor	

**NOTE 1**: Available as a free download here: www.hp.com/go/performanceadvisor **NOTE 2**: Supports both 32 and 64 bit versions of Windows 7 Professional and Enterprise,

Windows XP Professional and Enterprise, and RHEL V6

NOTE 3: Must select as a Configure to Order option. Delivered as a "Drop in the Box" CD

NOTE 4: Must select as a Configure to Order option

Operating Systems		Support Notes
	Genuine Windows® 7 Ultimate 64-bit	See note 1
	Genuine Windows® 7 Professional 32-bit	See note 1
	Genuine Windows® 7 Professional 64-bit	See note 1
	SUSE Linux Enterprise Desktop 11	
	HP Linux Installer Kit	
	Red Hat Enterprise Linux (RHEL) Workstation - Paper License (1yr)	See note 2

NOTE 1: See http://www.microsoft.com/windows/windows-7/ for support details.

NOTE 2: This second OS must be ordered with the HP Linux Installer Kit as the first OS.



### System Technical Specifications

System	Board								
System Bo Factor	ard Form	ATX 243.8	4 x 304.8 m	m (9.6 x 12	! inches)				
Processor	Socket	Single LGA	A2011						
CPU Bus S	peed	QPI: Up to	8.0GT/sec						
Chipset		Intel® C60	2 Chipset						
Super I/O (	Controller	Nuvoton N	voton NPCD379H (SIO-12)						
Memory Ex Slots	pansion	8 DDR3 m	DDR3 memory slots						
Memory Ty Supported	/pe	DDR3, UD	IMM (Unbuff	fered), ECC					
Memory Me	odes	Channel In	terleaved						
Memory S <sub>l</sub> Supported	peed	1066MHz,	1333MHz, a	and 1600MF	Hz DDR3				
Memory Pr	otection	ECC availa	able on data	, parity on a	address and	command			
Memory				<u> </u>					
Memory Co Table	onfiguration		er to the tabl		details on h	ow supporte	d memory o	configuration	is are
			Front	Slots			Rear	Slots	
Capacity (GB)	Туре	DIMM 1	DIMM 2	DIMM 3	DIMM 4	DIMM 5	DIMM 6	DIMM 7	DIMM 8
2	UDIMM	2GB							
4	UDIMM	2GB							2GB
6	UDIMM	2GB		2GB					2GB
8	UDIMM	2GB		2GB			2GB		2GB
16	UDIMM	2GB	2GB	2GB	2GB	2GB	2GB	2GB	2GB
16 32	UDIMM UDIMM	4GB 4GB	4CB	4GB	4CB	4CB	4GB	4CD	4GB
32	UDIMM	8GB	4GB	4GB 8GB	4GB	4GB	4GB 8GB	4GB	4GB 8GB
64	UDIMM	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB
	ad Order	1	5	3	7	8	4	6	2
	For a detaile	ed diagram,		•	el located on	the inside o		n side pane	
	onfiguration		•	supported.					
Note on Ma Memory	aximum	*Maximum memory capacities assume 64-bit operating systems such as Genuine Window 7 Ultimate 64-bit or Genuine Windows® 7 Professional 64-bit. Genuine Windows® 7 Professional 32-bit supports up to 4GB. Linux 32-bit supports up to 8GB.							
PCI Expres Connectors		2 x16 PCle Gen3 1 x8 PCle Gen3 1 x8 PCle (x4) Gen2 1 x4 PCle (x1) Gen2							
PCI Conne	ctors (5.0V)	1 PCI							
Supported Drive Interfaces  SATA  Integrated 10-channel SATA interface (2@6Gb/s Supports RAID 0, 1, 5, 10 and NCQ. Factory interface Microsoft Windows only.			2h/c 8@3C	h/s)					



Integrated Graphics

NOTE: Requires identical hard drives (speeds, capacity, interface)

Integrated RAID

No

### System Technical Specifications

Network Controller	Integrated Intel 82579 G	bit LAN
	Supports the following mPXE 2.1	nanagement functionalities: Intel AMT7.0, TXT, DASH 1.1, WOL, and
External SATA (eSATA)	6 ports are eSATA confi	gurable with optional eSATA After-Market Option cable kit.
IDE connector	No	
Floppy connector	No	
Serial	1 internal header	
2nd Serial	No	
Parallel	No	
AUX IN (audio)	No	
IEEE 1394	Front	1 IEEE 1394a standard
Connector(s)	Rear	1 IEEE 1394a standard; 2 IEEE 1394b (requires optional PCle card)
	Internal	No
USB Connector(s)	Front	2 USB 3.0 1 USB 2.0
	Rear	2 USB 3.0 4 USB 2.0
	Internal	6 USB 2.0 ports available by three separate 2x5 headers: each header supports either a HP Internal USB Port Kit or USB Media Card Reader, one on each header. Each Internal Port Kit has two USB 2.0 connectors.
HD Integrated Audio	Realtek ALC262	
Flash ROM	Yes	
CPU Fan Header	Yes	
Chasiss Fan Header	1 Rear System Chassis	Fan Header
Front PCI Fan Header	Yes	
Front Control	Yes	
Panel/Speaker Heade CMOS Battery Holder		
- Lithium		
Integrated Trusted Platform Module	Integrated TPM 1.2	
Power Supply Headers	Yes	
Power Switch, Power LED & Hard Drive LED Header		
Clear Password Jumper	Yes	
Serial Port	1 internal header	
Parallel Port	No	
Keyboard/Mouse	USB or PS/2	

#### **Power Supply**



Power Supply	600W 90% Efficient, Custom PSU (Wide Ranging, Active PFC)		
Operating Voltage Range	90–26	9 VAC	
Rated Voltage Range	100–240 V	118 V	
Rated Line Frequency	50–60 Hz	400 Hz	
Operating Line Frequency Range	47–66 Hz	393-407 Hz	
Rated Input Current	100-240 V @ 8.0 A	118 V @ 8.0 A	
Heat Dissipation	Typical: 1365btu/hr (344 kg-cal/hr) Maximum: 2354btu/hr (593 kg-cal/hr)		
Power Supply Fan	92x25 mm v	ariable speed	
ENERGY STAR Qualified (Configuration dependent)	Yes		
80 PLUS® Compliant	Yes, 90% Efficient The Z420 600W power supply efficiency report can be for this link: TBD		
FEMP Standby Power Compliant @115V (Wake-on LAN disabled) (<2W in S5 - Power Off)	Ye	es	
EuP Compliant @ 230V (<1 W in S5 - Power Off)	Ye	es	
CECP Compliant @ 220V (<4W in S3 - Suspend to RAM)	Yes; Configuration dependent		
Power Consumption in sleep mode (as defined by ENERGY STAR) - Suspend to RAM (S3) (Instantly Available PC) measured at 115V.			
Built-in Self Test LED	Ye	es	
Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V)			

Hood Lock Header	Yes
<b>Hood Sensor Header</b>	Yes
Memory Fan	1 Memory Fan Header



System Configurations	5						
Example	Processor Info	1x Intel Xec	n E5-1603	(Quad-Core	)		
Configuration #1		1x 2GB DDR3 1600 (UDIMM)					
(ENERGY STAR	Graphics Info	1x NVIDIA NVS 300					
QUALIFIED)	Disks/Optical/Floppy	1x 250GB SATA 7200/1x 16X DVD-ROM SATA					
	PSU	600W 90% Custom PSU					
	Other	_					
Energy Consumption		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	50.0	0 W	48.9	9 W	49.	5 W
	Windows Busy Typ (S0)	118	3 W	115	5 W	118	3 W
	Windows Busy Max (S0)	130	) W	127	7 W	129	9 W
	Sleep (S3)	3.56 W	3.42 W	3.782 W	3.66 W	3.53 W	3.41 W
	Off (S5)	1.34 W	1.20 W	1.58 W	1.45 W	1.31 W	1.18 W
	Zero Power Mode (ErP)	0.20	0 W	0.43	3 W	0.1	7 W
Heat Dissipation**		115	VAC	230 VAC 100 VAC		VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	171 b	otu/hr	167 b	tu/hr	169 b	tu/hr
	Windows Busy Typ (S0)	403 b	otu/hr	392 b	otu/hr	403 k	otu/hr
	Windows Busy Max (S0)	444 b	otu/hr	433 b	otu/hr	440 k	otu/hr
	Sleep (S3)	12.2 btu/hr	11.7 btu/hr	12.9 btu/hr	12.5 btu/hr	12.0 btu/hr	11.6 btu/hr
	Off (S5)	4.57 btu/hr	4.09 btu/hr	5.39 btu/hr	4.95 btu/hr	4.47 btu/hr	4.03 btu/hr
	Zero Power Mode (ErP)	0.68	btu/hr	1.47	btu/hr	0.58	btu/hr

Example	Processor Info	1x Intel Xec	n F5-1650	(Six-Core)			
Configuration #2		2x 4GB DDR3 1600 (UDIMM)					
(ENERGY STAR	,	1x NVIDIA Quadro 2000					
QUALIFIED)	Disks/Optical/Floppy	2x 500GB S	SATA 7200/	1x 16X DVI	D+-RW Sup	erMulti SAT	Α
	Power Supply	600W 90% Custom PSU					
	Other	-					
Energy Consumption		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	73.9	9 W	72.	9 W	73.8	3 W
	Windows Busy Typ (S0)	272	2 W	270	) W	277	' W
	Windows Busy Max (S0)	298	298 W 294 W 300 W		) W		
	Sleep (S3)	4.31 W	4.18 W	4.53 W	4.41 W	4.27 W	4.17 W
	Off (S5)	1.35 W	1.20 W	1.59 W	1.44 W	1.32 W	1.17 W
	Zero Power Mode (ErP)	0.2	1 W	0.4	3 W	0.17	7 W
Heat Dissipation**		115	115 VAC 230 VAC		100	VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	252 b	otu/hr	249 b	otu/hr	252 b	tu/hr
	Windows Busy Typ (S0)	928 b	tu/hr	921 b	tu/hr	945 b	tu/hr
	Windows Busy Max (S0)	1017	1017 btu/hr 1003 btu/hr		1024	btu/hr	
	Sleep (S3)	14.7 btu/hr	14.3 btu/hr	15.5 btu/hr	15.1 btu/hr	14.6 btu/hr	14.2 btu/hr
	Off (S5)	4.61 btu/hr	4.09 btu/hr	5.43 btu/hr	4.91 btu/hr	4.50 btu/hr	3.99 btu/hr
	Zero Power Mode (ErP)	0.72	btu/hr	1.47	btu/hr	0.58 l	otu/hr



Example	Processor Info	1x Intel Xed	on E5-2665	(Eight-Core	)		
Configuration #3	Memory Info	8x 4GB DD	R3 1600 (U	DIMM)			
	Graphics Info	1x NVIDIA Quadro 5000					
	Disks/Optical/Floppy	4x 600GB \$	SAS 15K/1x	( 16X DVD+	-RW Super	Multi SATA	
	Power Supply		600W 90% Custom PSU				
	Other	LSI 9212 S	AS Card				
Energy Consumption			VAC		VAC		VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	152	2 W	15°	1 W	154	1 W
	Windows Busy Typ (S0)	347	7 W	346	6 W	354	1 W
	Windows Busy Max (S0)	421	1 W	430	) W	432	2 W
	Sleep (S3)	6.77 W	6.68 W	6.96 W	6.82 W	6.79 W	6.63 W
	Off (S5)	1.33 W	1.20 W	1.55 W	1.42 W	1.30 W	1.18 W
	Zero Power Mode (ErP)	0.19	9 W	0.4	1 W	0.10	6 W
Heat Dissipation**		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	519 b	otu/hr	515 k	otu/hr	525 b	otu/hr
	Windows Busy Typ (S0)	1184	btu/hr	1181	btu/hr	1208	btu/hr
	Windows Busy Max (S0)	1437	btu/hr	1467	btu/hr	1474	btu/hr
	Sleep (S3)	23.1 btu/hr	23.8 btu/hr	23.8 btu/hr	23.3 btu/hr	23.2 btu/hr	22.6 btu/hr
	Off (S5)	4.54 btu/hr	4.09 btu/hr	5.29 btu/hr	4.85 btu/hr	4.44 btu/hr	4.03 btu/hr
	Zero Power Mode (ErP)	0.65	btu/hr	1.40	btu/hr	0.55	btu/hr

Declared Noise Emissions (Entry-level and High-end configurations)					
System Configuration	Processor Info	Intel Xeon E5-2665 2.40 GHz			
(Entry level)	Memory Info	4 - DDR3 2 GB 1600 MHz UDIMM			
	Graphics Info	NVIDIA Q400			
	Disks/Optical/Floppy	Single 500 GB 7200 RPM SATA DVD-RW			

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels
	Idle	3.5	18
	SATA Hard drive Operating (random reads)	3.6	19
	DVD-ROM Operating (sequential reads)	5.2	37

System Configuration	Processor Info	Intel Xeon E5-1660 3.30 GHz
(High-end)	Memory Info	8 - 4 GB DDR3 1600 MHz UDIMM
	Graphics Info	NVIDIA Q4000
	Disks/Optical/Floppy	2 - 600 GB 15K RPM SAS 3.5"
		DVD-RW



Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels	
	Idle	4.9	32	
	SATA Hard drive Operating (random reads)	5.0	34	
	DVD-ROM Operating (sequential reads)	5.3	41	

Environmental Requirements	Temperature	Operating: 5° to 35° C (40° to 95° F) Non-operating: -40° to 60° C (-40° to 140° F)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 3,000 m (10,000 feet) Non-operating: 9,100 m (30,000 feet)
	Dynamic (new)	Shock Operating: ½-sine: 40g, 2-3ms Non-operating: ½-sine: 160 cm/s, 2-3ms (~100g) square: 422 cm/s, 20g NOTE: Values represent individual shock events and do not indicate repetitive shock events.  Vibration Operating random: 0.5g (rms), 5-300 Hz Non-operating random: 2.0g (rms), 10-500 Hz NOTE: Values do not indicate continuous vibration.
	Cooling	Above 1524 m (5,000 ft) altitude, maximum operating temperature is de-rated by 1° C (1.8° F) per 305 m (1,000 ft) elevation increase

<b>Physical Securit</b>	Physical Security and Serviceability			
Access Panel	Tool-less Includes system board and memory information.			
Optical Drive	Tool-less			
Hard Drives	Tool-less			
Expansion Cards	Tool-less			
Processor Socket	Tool-less			
Green User Touch Points	Yes, on primary serviceable components.			
Color-coordinated Cables and Connectors	Yes			
Memory	Tool-less			
System Board	Screw-In			
Dual Color Power and HD LED on Front of Computer	Yes			
Configuration Record SW	Yes			



Over-Temp Warning on Screen	Yes, at POST screen on reboot
Restore CD/DVD Set	Restores the computer to its original factory shipping image; can be obtained via HP Support.
Dual Function Front Power Switch	Yes, causes a fail-safe power off when held for 4 seconds
Padlock Support	Yes (optional): Locks side cover and secures chassis from theft 5.56 mm (0.2188 in) diameter padlock loop at rear of system
Cable Lock Support	Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm slot at rear of system
Universal Chassis Clamp Lock Support	Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units to be chained together when used with optional cable Threaded feature at rear of system
Solenoid Lock and Hood Sensor	Yes (optional) The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The Sensor Kit detects when the access panel has been removed
Rear Port Control Cover	Yes (optional);locks rear IO cables to prevent cable theft
Serial, Parallel, USB, Audio, Network, Enable/Disable Port Control	Yes, enables or disables serial, USB, audio, and network ports
Removable Media Write/Boot Control	Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media)
Power-On Password	Yes, prevents an unauthorized person from booting up the workstation
Setup Password	Yes, prevents an unauthorized person from changing the workstation configuration
3.3V Aux Power LED on System PCA	Yes
NIC LEDs (integrated) (Green & Amber)	Yes
, ,	Yes  A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less
(Green & Amber)	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU
(Green & Amber) CPUs and Heatsinks Power Supply	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less
(Green & Amber) CPUs and Heatsinks Power Supply Diagnostic LED	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less  Yes
(Green & Amber) CPUs and Heatsinks Power Supply Diagnostic LED Front Power Button	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less  Yes  Yes, ACPI multi-function
(Green & Amber) CPUs and Heatsinks Power Supply Diagnostic LED Front Power Button Rear Power Button	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less  Yes  Yes, ACPI multi-function  Yes
(Green & Amber) CPUs and Heatsinks  Power Supply Diagnostic LED  Front Power Button Rear Power Button Front Power LED  Front Hard Drive	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less  Yes  Yes, ACPI multi-function  Yes  Yes, blue (normal), red (fault)
(Green & Amber) CPUs and Heatsinks  Power Supply Diagnostic LED Front Power Button Rear Power Button Front Power LED Front Hard Drive Activity LED Front ODD Activity	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less  Yes  Yes, ACPI multi-function  Yes  Yes, blue (normal), red (fault)  Yes, green
(Green & Amber) CPUs and Heatsinks  Power Supply Diagnostic LED Front Power Button Rear Power Button Front Power LED Front Hard Drive Activity LED Front ODD Activity LED	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less  Yes  Yes, ACPI multi-function  Yes  Yes, blue (normal), red (fault)  Yes, green  Yes
(Green & Amber) CPUs and Heatsinks  Power Supply Diagnostic LED Front Power Button Rear Power Button Front Power LED Front Hard Drive Activity LED Front ODD Activity LED Internal Speaker System/Emergency	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less  Yes  Yes, ACPI multi-function  Yes  Yes, blue (normal), red (fault)  Yes, green  Yes
(Green & Amber) CPUs and Heatsinks  Power Supply Diagnostic LED Front Power Button Rear Power Button Front Power LED Front Hard Drive Activity LED Front ODD Activity LED Internal Speaker System/Emergency ROM Flash Recovery	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less  Yes  Yes, ACPI multi-function  Yes  Yes, blue (normal), red (fault)  Yes, green  Yes  Recovers corrupted system BIOS.
(Green & Amber) CPUs and Heatsinks  Power Supply Diagnostic LED Front Power Button Rear Power Button Front Power LED Front Hard Drive Activity LED Front ODD Activity LED Internal Speaker System/Emergency ROM Flash Recovery Cooling Solutions	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less  Yes  Yes, ACPI multi-function  Yes  Yes, blue (normal), red (fault)  Yes, green  Yes  Recovers corrupted system BIOS.  Air cooled forced convection, liquid cooling (optional)
(Green & Amber) CPUs and Heatsinks  Power Supply Diagnostic LED Front Power Button Rear Power Button Front Power LED Front Hard Drive Activity LED Front ODD Activity LED Internal Speaker System/Emergency ROM Flash Recovery Cooling Solutions Power Supply Fans	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less  Yes  Yes, ACPI multi-function  Yes, blue (normal), red (fault)  Yes, green  Yes  Recovers corrupted system BIOS.  Air cooled forced convection, liquid cooling (optional)  92 mm x 92 mm x 25 mm 4-wire (non-serviceable)
(Green & Amber) CPUs and Heatsinks  Power Supply Diagnostic LED Front Power Button Rear Power Button Front Power LED Front Hard Drive Activity LED Front ODD Activity LED Internal Speaker System/Emergency ROM Flash Recovery Cooling Solutions Power Supply Fans CPU Heatsink Fan	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less  Yes  Yes, ACPI multi-function  Yes  Yes, blue (normal), red (fault)  Yes, green  Yes  Recovers corrupted system BIOS.  Air cooled forced convection, liquid cooling (optional)  92 mm x 92 mm x 25 mm 4-wire (non-serviceable)  92 x 25 mm 5-wire PWM  92 mm x 92mm x 25 mm 4-wire PWM
(Green & Amber) CPUs and Heatsinks  Power Supply Diagnostic LED Front Power Button Rear Power Button Front Power LED Front Hard Drive Activity LED Front ODD Activity LED Internal Speaker System/Emergency ROM Flash Recovery Cooling Solutions Power Supply Fans CPU Heatsink Fan Chassis Fan Memory Heatsink Fan	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less  Yes  Yes, ACPI multi-function  Yes  Yes, blue (normal), red (fault)  Yes, green  Yes  Recovers corrupted system BIOS.  Air cooled forced convection, liquid cooling (optional)  92 mm x 92 mm x 25 mm 4-wire (non-serviceable)  92 x 25 mm 5-wire PWM  92 mm x 92mm x 25 mm 4-wire PWM



#### System Technical Specifications

and software configuration information from various sources. This utility enables you to: Run diagnostics View the hardware configuration of the system Key features and benefits HP Vision Diagnostics simplifies the process of effectively identifying, diagnosing, and isolating the hardware issues. In addition to robust management tools, service tools can be invaluable in quickly resolving system problems. To streamline the service process and resolve problems quickly, it is necessary to have the right information available at the time that a service call is placed. The primary information requirement, which is also the one that provides the greatest Vision into potential system issues, is the configuration of the system. Vision Diagnostics helps provide higher system availability. Typical uses of the Vision Diagnostics are: Testing and diagnosing apparent hardware failures Documenting system configurations for upgrade planning, standardization, inventory tracking, disaster recovery, and maintenance Sending configuration information to another location for more in-depth analysis Access Panel Key No Lock ACPI-Ready Hardware Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system **Trusted Platform** Yes, Infineon SLB9635TT1.2 Module Chip with optional ProtectTools **Software Integrated Chassis Handles** Optional Handle in Top Optical Bay kit **Power Supply** Requires T15 Torx or flat blade screwdriver **PCI Card Retention** Yes, rear (all), middle (optional), front (full-length cards with extender, used in with the front card guide and fan holder) Flash ROM Yes **Diagnostic Power** Yes Switch LED on board Clear Password Yes **Jumper Clear CMOS Button** Yes CMOS Battery Holder Yes **DIMM Connectors** Yes

BIOS	
BIOS 32-bit Services	Standard BIOS 32-bit Service Directory Proposal v0.4
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces.
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0.
BBS	BIOS Boot Specification v1.01.

Yes - Not supported on Linux



**HP ProtectTools** 

Security Manager

System recinical C	specimental in the second seco
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot.
BIOS Power On	Users can define a specific date and time for the system to power on.
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS.
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM
Replicated Setup	Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).
SMBIOS	System Management BIOS 2.7, for system management information.
Boot Control	Disables the ability to boot from removable media on supported devices.
Memory Change Alert	Alerts management console if memory is removed or changed.
Thermal Alert	Monitors the temperature state within the chassis. Three modes:
	<ul> <li>NORMAL - normal temperature ranges.</li> <li>ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.</li> <li>SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.</li> </ul>
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console.
ACPI (Advanced Configuration and Power Management Interface)	Allows the system to enter and resume from low power modes (sleep states).  Enables an operating system to control system power consumption based on the dynamic workload.  Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.
Remote Wakeup/ Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location.
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time.
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system.
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.
System board revision level	Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.
Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing
Auto Setup when new hardware installed	System automatically detects addition of new hardware.
Keyboard-less Operation	The system can be booted without a keyboard.



### System Technical Specifications

Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.			
Asset Tag	The user or MIS to set a unique tag string in non-volatile memory.			
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually.			
Adaptive Cooling	Control parameters are set according to detected hardware configuration for optimal acoustics.			
Pre-boot Diagnostics	(Pre-video) critical errors are reported via beeps and blinks on the power LED			
Industry Standard Spe	ecification Support			
Industry Standard	Revision Supported by the BIOS			
ACPI	Advanced Configuration and Power Management Interface, Version 2.0c			
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b			
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0			
EDD	<ul> <li>Enhanced Disk Drive Specification Version 1.1</li> <li>BIOS Enhanced Disk Drive Specification Version 3.0</li> </ul>			
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0			
PCI	PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7			
PCI Express	PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0			
PMM	POST Memory Manager Specification, Version 1.01			
SATA	<ul> <li>Serial ATA Specification, Revision 1.0a</li> <li>Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5</li> <li>Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0</li> </ul>			
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B			
TPM	Trusted Computing Group TPM Specification Version 1.2			
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1			
USB	Universal Serial Bus Revision 1.1 Specification			
	Universal Serial Bus Revision 2.0 Specification			
	Universal Serial Bus Revision 3.0 Specification			
SMBIOS	System Management BIOS Reference Specification, Version 2.7			

#### Social and Environmental Responsibility

Social and Envi	ronmental Responsibility
Eco-Label Certificatio & Declarations	This product has received or is in the process of being certified to the following approvals and ma be labeled with one or more of these marks:
	<ul> <li>ENERGY STAR® (energy-saving features available on selected configurations-Windows only)</li> <li>US Federal Energy Management Program (FEMP)</li> <li>China Energy Conservation Program</li> <li>IT ECO declaration</li> <li>Japan PC Green label*</li> </ul>
	*This product conforms to the examination standards (2003 version) under JEITA's 'PC Green Label System.'
Batteries	The battery in this product complies with EU Directive 2006/66/EC Battery size: CR2032 (coin cell) Battery type: Lithium Metal
· ———	<u> </u>

	The battery in this product does not contain:			
	<ul> <li>Mercury greater than 5ppm by weight</li> <li>Cadmium greater than 10ppm by weight</li> <li>Lead greater than 40ppm by weight</li> </ul>			
Restricted Material Usage	This product meets the material restrictions specified in HP's General Specification for the Environment. http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf			
	Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis.  This product is brominated flame retardant and polyvinyl chloride-free (BFR/PVC-free); meeting the evolving definition of "BFR/PVC-free" as set forth in the "iNEMI Position Statement on the 'Definition of Low-Halogen Electronics (BFR/CFR/PVC-Free)." Plastic parts contain <1,000 ppm (0.1 percent) of bromine (if the Br source is from BFRs) and <1,000 ppm (0.1 percent) of chlorine (if the CI source is from CFRs or PVC or PVC copolymers). All printed circuit board (PCB) and substrate laminates contain bromine/chlorine total <1,500 ppm (0.15 percent) with a maximum chlorine of 900 ppm (0.09 percent) and maximum bromine being 900 ppm (0.09 percent). Service parts after purchase may not be BER/PVC free. Exceptions to this claim that may be shipped we			
	parts after purchase may not be BFR/PVC-free. Exceptions to this claim that may be shipped w the product include the power cord, keyboard, mouse and video adapters which may not be BFR/PVC-free.			
BFR/PVC-Free Statement	Configurations of the HP Z420 Workstation where SAS 3 ½" HDDs, Intel SAS Controller Module, Creative Recon3D PCIe Audio Card, Broadcom 5761 Gigabit PCIe NIC, or LSI 9260-8i SAS 6Gb/ROC RAID Card are not selected are brominated flame retardant and polyvinyl chloride free (BFR/PVC-free), meeting the evolving definition of "BFR/PVC-free" as set forth in the iNEMI Position Statement on the Definition of Low-Halogen Electronics (BFR/CFR/PVC-Free). http://thor.inemi.org/webdownload/projects/ese/HFR-Free/Low-Halogen_Def.pdf			
End-of-Life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.			
Hewlett-Packard Corporate Environmental Information	For more information about HP's commitment to the environment, please see the Global Citizenship Report: http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html			
	This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).  EPEAT Gold - ENERGY STAR qualified configurations of this product are in compliance with the IEEE 1680 (EPEAT) standard at the Gold level where HP registers workstation products. See <a href="Insert platform specific EPEAT">Insert platform specific EPEAT linkTBD</a> for registration status in your country.			
Packaging	HP Workstation product packaging meets the following (refer to the HP General Specification for the Environment at			
	http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html:			
	<ul> <li>Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment (see link above).</li> <li>Does not contain ozone-depleting substances (ODS).</li> <li>Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excerof 100 ppm sum total for all heavy metals listed.</li> <li>Maximize the use of post-consumer recycled content materials in packaging materials.</li> <li>All packaging material is recyclable.</li> <li>All packaging material is designed for ease of disassembly.</li> <li>Reduce size and weight of packages to improve transportation fuel efficiency.</li> <li>Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.</li> </ul>			



Packaging Materials		
Internal	LDPE Foam and Bag: .465 kg	
External	Cardboard carton and insert: 1.610 kg	

Manageability					
Industry Standard Specifications	This product meets the following industry standard specifications for manageability functionality:				
	DASH 1.1 required functionalities via Intel LAN on motherboard				
Intel Active	Intel Active Management Technology (AMT) 7.0				
Management					
Technology (AMT)	An advanced set of remote management features and functionality providing IT administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 7.0 includes the following advanced management functions:				
	Power Management (on, off, reset)				
	Hardware Inventory (includes BIOS and firmware revisions)				
	Hardware Alerting				
	Agent Presence     System Reference Filters				
	<ul> <li>System Defense Filters</li> <li>SOL/IDER</li> </ul>				
	Cisco NAC/SDN Support				
	ME Wake-on-LAN				
	DASH 1.1 compliance				
	IPv6 Support				
	• Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIOS				
	screen, periodic connections, or alert triggered connection				
	Remote Scheduled Maintenance - pre-schedule when the system connects to the IT or				
	service provider console for maintenance.				
	Remote Alerts - automatically alert IT or service provider if issues arise				
	Access Monitor - Provides oversight into Intel® AMT actions to support security				
	requirements				
	PC Alarm Clock     Microsoft NAR Support				
	<ul> <li>Microsoft NAP Support</li> <li>Host Base set-up and configuration</li> </ul>				
	<ul> <li>Host Base set-up and configuration</li> <li>Management Engine (ME) firmware roll back</li> </ul>				
Intel® vPro™	The HP Z420 Workstation supports Intel vPro technology when configured as outlined below:				
	The HP 2420 Workstation supports litter vPro technology when configured as outlined below.				
Technology	Intel Xeon processor E5-1600 product family or E5-2600 product family featuring Intel vPro Technology				
	Intel C602 chipset				
	Intel 82579LM GbE LAN				
Remote Manageability	The HP Z420 Workstation is supported on the following remote manageability software consoles				
Software Solutions					
	LANDesk Management Suite (HP recommended solution)				
	Microsoft System Center Configuration Manager				
	HP Client Automation Enterprise				
	For questions or support for manageability needs, please visit http://www.hp.com/go/easydeploy				
System Software Manager	For questions or support for SSM, please visit: http://www.hp.com/go/ssm				
Service, Support, and	On-site Warranty and Service (Note 1): Three-years, limited warranty and service offering delivers				
Warranty	on-site, next business-day (Note 2) service for parts and labor and includes free telephone support				
	(Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one countr				
	and transferred to another, non-restricted country will remain fully covered under the original				
	warranty and service offering.				

#### System Technical Specifications

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country. NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries.

HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at <a href="http://www.hp.com/go/lookuptool">http://www.hp.com/go/lookuptool</a>. Additional HP Care Packs information by product is available at <a href="http://www.hp.com/hps/carepack">http://www.hp.com/hps/carepack</a>. Service levels and response times for HP Care Packs may vary depending on your geographic location.

### Product Change Notification

- Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile.
- PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.
- Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.



#### Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduct this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost, no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors	Product #	Offering		
	A2H76AV	Intel® Xeon® Processor E5-1620 4C 3.60GHz		
Hard Drives	Product #	Offering		
	QE198AV	HP 500 GB SATA 7200 1st HDD		
	QE199AV	HP 500 GB SATA 7200 2nd HDD		
	QE200AV	HP 500 GB SATA 7200 3rd HDD		
	QE201AV	HP 500 GB SATA 7200 4th HDD		
	QE190AV	HP 1 TB SATA 7200 1st HDD		
	QE191AV	HP 1 TB SATA 7200 2nd HDD		
	QE192AV	HP 1 TB SATA 7200 3rd HDD		
	QE193AV	HP 1 TB SATA 7200 4th HDD		
Graphics	Product #	Offering		
	A7U44AV	NVIDIA NVS 310 512MB Graphics		
	A7U45AV	NVIDIA NVS 310 512MB Graphics (2nd)		
Memory	Product #	Offering		
•	QE252AV	2GB (1x2GB) DDR3-1600 ECC Unbuffered RAM		
	QE254AV	4GB (2x2GB) DDR3-1600 ECC Unbuffered RAM		
	B0Q75AV	6GB (3x2GB) DDR3-1600 ECC Unbuffered RAM		
	QE256AV	8GB (4x2GB) DDR3-1600 ECC Unbuffered RAM		
	QE258AV	16GB (8x2GB) DDR3-1600 ECC Unbuffered RAM		
	QE257AV	16GB (4x4GB) DDR3-1600 ECC Unbuffered RAM		
	QE260AV	32GB (8x4GB) DDR3-1600 ECC Unbuffered RAM		
Optical and Remova	bleProduct#	Offering		
Storage	QE236AV	HP 16X DVD+-RW SuperMulti SATA 1st Drive		
	QE237AV	HP 16X DVD+-RW SuperMulti SATA 2nd Drive		
Operating Systems	Product #	Offering		
	QD971AV	Genuine Windows® 7 Professional 64-bit		



### Technical Specifications - Processors

Processors Intel® Xeon® Processor E5-2665 8C 2.40GHz

Intel® Xeon® Processor E5-2687W 8C 3.10GHz

Intel® Xeon® Processor E5-1660 6C 3.30GHz Intel® Xeon® Processor E5-1650 6C 3.20GHz Intel® Xeon® Processor E5-1620 4C 3.60GHz Intel® Xeon® Processor E5-1607 4C 3.00GHz Intel® Xeon® Processor E5-1603 4C 2.80GHz

#### **Processor Note**

For detailed processor specifications, please refer to the Overview section at the beginning of this document.



#### Technical Specifications - Hard Drives

HP SAS (Serial Attached SCSI) Hard Drives for HP Workstations 600GB SAS 15K rpm 6Gb/s 3.5" HDD Capacity600GBHeight1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

InterfaceSASSynchronous Transfer6.0 Gb/s

Rate (Maximum)

Buffer 16 MB

Seek Time (typical<br/>reads, includes controller<br/>overhead, including<br/>settling)Single Track<br/>Average<br/>Full Stroke0.2 ms3.4 ms<br/>6.6 ms

Rotational Speed 15,000 rpm

**Logical Blocks** 1,172,123,568 - 512 byte blocks **Operating Temperature**50° to 95° F (10° to 35° C)

450GB SAS 15K rpm 6Gb/s 3.5" HDD Capacity 450GB Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Interface SAS
Synchronous Transfer 6Gb/s

Rate (Maximum)

Buffer 16MB

Seek Time (typical<br/>reads, includes controller<br/>overhead, including<br/>settling)Single Track<br/>Average<br/>Full Stroke0.2 ms3.4 ms<br/>6.6 ms

Rotational Speed 15,000 rpm

Operating Temperature 50° to 95° F (10° to 35° C)

300GB SAS 15K rpm 6Gb/s 3.5" HDD 
 Capacity
 300GB

 Height
 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

**Interface** SAS **Synchronous Transfer** 6Gb/s

Rate (Maximum)

**Buffer** 16MB

Seek Time (typical<br/>reads, includes controller<br/>overhead, including<br/>settling)Single Track<br/>Average<br/>Full Stroke0.2 ms<br/>3.4 ms<br/>6.6 ms

Rotational Speed 15,000 rpm

**Operating Temperature**50° to 95° F (10° to 35° C)

HP 300GB SAS 10K SFF HDD Capacity 300GB

**Height** 0.6 in; 1.53 cm



#### Technical Specifications - Hard Drives

Width Media Diameter 2.5 in; 6.36 cm

Physical Size 2.75 in; 6.99 cm

Interface SAS 6Gb/s
Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 64MB

Cachemulti-segmentable cache bufferSeek Time (typical reads, includes controllerSingle Track Average0.4 ms (max)Average3.6 ms

overhead, including

settling) Full Stroke 7.3 ms

**Rotational Speed** 10,000 rpm **Logical Blocks** 585,937,500

**Operating Temperature**41° to 131° F (5° to 55° C)

HP 600GB SAS 10K SFF HDD Capacity 600GB

**Height** 0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm

Physical Size 2.75 in; 6.99 cm

**Interface** SAS 6Gb/s **Synchronous Transfer** Up to 600MB/s

Rate (Maximum)

**Buffer** 64MB

Cachemulti-segmentable cache bufferSeek Time (typical reads, includes controller overhead, including settling)Single Track out of the cache bufferAverage overhead, including settling)Average out of the cache bufferFull Stroke7.3 ms

Rotational Speed 10,000 rpm
Logical Blocks 1,172,123,568

Operating Temperature41° to 131° F (5° to 55° C)

SATA (Serial ATA) Hard3.0TB SATA 7200 rpm Drives for HP 6Gb/s 3.5" HDD

Workstations

Capacity 3.0TB

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4.0 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 6.0 Gb/s

Rate (Maximum)

**Buffer** 64MB

Seek Time (typical<br/>reads, includes controller<br/>overhead, includingSingle Track<br/>Average0.6 ms11 ms

settling) Full Stroke

Rotational Speed 7,200 rpm

**Operating Temperature**41° to 140° F (5° to 60° C)

2.0TB SATA 7200 rpm Capacity 2.0TB



Not Specified

#### Technical Specifications - Hard Drives

6Gb/s 3.5" HDD Height 1 in; 2.54 cm

> Width **Media Diameter** 3.5 in: 8.9 cm

> > **Physical Size** 4 in; 10.17 cm

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer Up to 600 MB/s

Rate (Maximum)

**Buffer** 64MB

Seek Time (typical **Single Track** 1.0 ms reads, includes controller Average 11 ms overhead, including

**Full Stroke** 18 ms settling)

**Rotational Speed** 7,200 rpm Logical Blocks 3,907,029,168

Operating Temperature41° to 131° F (5° to 55° C)

1TB SATA 7200 rpm 6Gb/s 3.5" HDD

1 Terabyte (1000 GB) Capacity

Height 1 in: 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4.0 in: 10.17 cm

Serial ATA (6.0Gb/s), NCQ enabled Interface

**Synchronous Transfer** Up to 600 MB/s

Rate (Maximum)

**Buffer** 32MB

Seek Time (typical Single Track 2 ms reads, includes controller Average 11 ms overhead, including **Full Stroke** 21 ms settling)

7,200 rpm **Rotational Speed Logical Blocks** 1,953,525,168

Operating Temperature41° to 131° F (5° to 55° C)

500GB SATA 7200 rpm Capacity 6Gb/s 3.5" HDD

500GB Height 1 in: 2.5 cm

Width **Media Diameter** 3.5 in; 8.9 cm 4 in; 10.17 cm **Physical Size** 

Interface Serial ATA (6.0Gb/s), NCQ enabled

**Synchronous Transfer** Up to 600MB/s

Rate (Maximum)

**Buffer** 16 MB

Seek Time (typical Single Track 2 ms reads, includes controller Average 11 ms overhead, including **Full Stroke** 21 ms settling)

**Rotational Speed** 7,200 rpm **Logical Blocks** 976,773,168

**Operating Temperature**41° to 131° F (5° to 55° C)

250GB SATA 7200 rpm Capacity 250 GB 6Gb/s 3.5" HDD

Height 1 in; 2.54 cm



#### Technical Specifications - Hard Drives

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4.0 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 8 MB

Seek Time (typical<br/>reads, includes controller<br/>overhead, including<br/>settling)Single Track<br/>Average2 ms11 ms<br/>Full Stroke21 ms

Rotational Speed 7,200 rpm Logical Blocks 488,397,168

**Operating Temperature**41° to 131° F (5° to 55° C)

HP Solid State Drives for Workstations

S HP 160GB SATA SSD

Capacity 160GB

Width Media Diameter NaN in; NaN cm

Physical Size 2.5 in; 6.36 cm

Interface SATA
Synchronous Transfer 3Gb/s

Rate (Maximum)

**Operating Temperature**32° to 158° F (0° to 70° C)

**HP 300GB SATA SSD** 

Capacity 300GB

Width Physical Size 2.5 in; 6.36 cm

InterfaceSATASynchronous Transfer3Gb/s

Rate (Maximum)

**Operating Temperature**32° to 158° F (0° to 70° C)



#### Technical Specifications - Hard Drive Controllers

LSI 9212 4-Port SAS 6Gb/s RAID Card PCI Bus 8-lane, 5GT/s PCI Express 2.0

PCI Modes Bus Master DMA RAID Levels RAID 0, 1, 1E and 10

PCI Data Burst Half Duplex, x4 PCIe 2000 MB/s Transfer Rate Full Duplex, x8 PCIe 4000 MB/s

SAS Bandwidth Half Duplex Single lane - 600 MB/s

Wide Port (2 lanes) - 1200 MB/s Wide Port (4 lanes) - 2400 MB/s

Full Duplex Single SAS Lane - 1200 MB/s

Wide Port (2 lanes) -2400 MB/s Wide Port (4 lanes) - 4800 MB/s

PCI Card Type3.3V Add-in cardPCI Voltage $12 V \pm 10\%$ PCI Power13.5 Watts

**Bracket** Full height and Low-profile

Certification Level PCI-Express 2.0

IO Bus 1x4 6Gb/s SAS ports

SAS Processor LSISAS2008 Internal Connectors Four x1 SATA

External Connectors

Maximum Number of

None 256

SCSI Devices

LED Indicators Internal

Activity/Fault per x4 port - Heartbeat

LSI MegaRAID® 9260-8iPCI Bus PCI-Express (Gen2) V2.0 x8 lanes

SAS 6Gb/s ROC RAID Card and iBBU08 Battery Backup Unit

PCI Modes

Bus Master DMA

RAID Levels

RAID 0, 1, 5, and 6

RAID spans 10, 50 and 60

Up to 4GB/s

PCI Data Burst Transfer Rate

**PCI Card Type** Low profile, single PCIe slot design with full height bracket.

The optional iBBU08 Battery Backup unit mounts on the controller care

and the assembly remains within a single PCIe slot width.

PCI Voltage +3.3V Add-in Card

PCI Power 12.5 Watts
Certification Level PCI-Express 2.0

IO Bus Eight 3 Gb/s and 6Gb/s compatible SAS/SATA ports

Internal Connectors Two SAS SFF8087 x4

External Connectors None Maximum Number of 32.

SCSI Devices NOTE: HP Workstations do not support this many internal drives.

LED Indicators Connector LEDs indicate whether the internal connector is active for

ports 0-3 and 4-7



#### Technical Specifications - Graphics

AMD FirePro 2270 512MB Graphics Card **Form Factor** Low Profile, Half Length, 2.3" x 6.6"

**Graphics Controller** AMD FirePro™ 2270 Professional Graphics

**Bus Type** PCI Express™ x16 Generation 2.0

Memory **512MB DDR3** 

**Connectors** DMS-59 connector to support breakout cables for dual DisplayPort, D\

and VGA output.

DMS-59 to Dual DVI adapter included.

(Display Port and VGA adapters sold separately)

**Maximum Resolution** Digital 2560x1600 (DisplayPort)

Analog 1920x1200 (DVI 60 Hz/ VGA 75Hz)

**RAMDAC** 400 MHz DAC, 10-bit per channel **Display Output** Card supports up to two displays

Supported Graphics

**APIs** 

DirectX 11 and OpenGL 4.0

**Available Graphics** 

**Drivers** 

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

**Power Consumption** 17W Maximum

**NVIDIA NVS 300 512MB Form Factor** 

**Graphics Card** 

**Graphics Controller** 

**NVIDIA NVS 300 Graphics Board Bus Type** PCI Express x16, Generation 2.0

Memory 512 MB GDDR3 SDRAM unified graphics memory

**Connectors DMS-59** 

Includes DMS-59 to Dual DVI-I adapter

2.7 inches (H) x 5.7 inches (L), Half-Height

DMS-59 to Dual DisplayPort adapter and DMS-59 to Dual VGA adapte

available as an option

DMS-59 to Dual DisplayPort adapter required for HP ZR30w Display

**Maximum Resolution** DVI: two digital displays up to 1920 x 1200

> DisplayPort: two digital displays up to 2560 x 1600 VGA: two analog displays up to 1920 x 1080

Image Quality Features

**Display Output** 

This card support up to two displays:

 Drives DVI enabled digital displays at resolutions up to 1920 x 1200 at 60 Hz with reduced blanking

• Drives DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking (through optional DMS-59 to DisplayPort adapter)

Drives VGA enabled analog displays at resolutions up to 1920 x 1080 (through optional DMS-59 to VGA adapter)

Supported Graphics

**APIs** 

**OGL 3.3** DirectX 10.1

**Available Graphics** 

**Drivers** 

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation



Technical Specifications - Graphics

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption <18 Watts

NVIDIA NVS 310 512MB Form Factor Low Profile:

**Graphics Card** 

2.713 inches in height × 6.150 inches in length

Graphics Controller NVIDIA NVS 310

**Bus Type** PCI Express x16, 2.0 compliant

Memory Size: 512MB DDR3

Clock: 875Mhz

Memory Bandwidth: 14GB/s

Connectors 2 x DisplayPort 1.2

**Maximum Resolution** Up to 2560 x 1600 (digital display) per display.

Image Quality Features See Display Output section.

The following video formats are supported:

- MPEG2

- MPEG4 Part 2 Advanced Simple Profile

H.264 SVC codec supportSupport for 3D Blu Ray

- VC1

- DivX version 3.11 and later

- MVC

A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 310 GPU provides hardware acceleration for the computationally intensive parts of video processing as well as provides improved video playback speeds via faster decode

and transcode.

**Display Output** Up to 2 displays in the following configurations:

DisplayPort output:

- Drives two DisplayPort enabled digital display at resolutions up t 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card
- Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz wireduced blanking using DisplayPort 1.2 multi stream topology technology.

#### DVI-D output:

- Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors
- Drives two digital display at resolutions up to 2560× 1600 at 60 I with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors

HDMI output:



#### Technical Specifications - Graphics

 NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors

#### VGA display output:

 Drives two analog display at resolutions up to 1920 × 1200 at 60 Hz using DisplayPort to VGA cable adaptors

**Shading Architecture** Supported Graphics

Shader Model 5.0 DX11, OpenGL 4.1

**APIs Available Graphics** 

**Drivers** 

Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

**Power Consumption** 

19.5 Watts

Note The thermal solution used on this card is an active fan heatsink.

**NVIDIA Quadro NVS** 450 512 MB PCIe **Graphics Card** 

**Form Factor** ATX Full Height, 1/2 length

Passive cooling

PCI Express x16, Generation 2.0 **Bus Type** Memory 512 MB GDDR3 (256MB per GPU)

**Connectors** Four DisplayPort;

Four DisplayPort to DVI-D adapters included.

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters

available as an accessory)

**Maximum Resolution** DisplayPort connectors support ultra-high-resolution panels (up to 256)

x 1600)

**NOTE:** This card supports up to four displays

**Supported Graphics** 

**APIs** 

OpenGL 3.0 DirectX 10.0

**Available Graphics** 

**Drivers** 

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Microsoft Windows Vista (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

**Power Consumption** <40 Watts



#### Technical Specifications - Graphics

NVIDIA Quadro 410 512MB Graphics

Form Factor Low Profile:

2.713 inches × 5.7 inches, single slot

Graphics Controller NVIDIA Quadro 410

**Bus Type** PCI Express x16, 3.0 compliant

Memory Size: 512MB DDR3
Clock: 900MHz

Memory Bandwidth: 14GB/s

Connectors One dual-link DVI-I connector

One DisplayPort connector

**Maximum Resolution** Up to 2560 x 1600 (digital display) per display.

**RAMDAC** 400 MHz integrated RAMDAC

**Display Output** Maximum resolution over DisplayPort: 2560 × 1600 × 32 bpp at 60 Hz

(reduced blanking)

Maximum resolution over DVI port: 2560 × 1600 × 32 bpp at 60 Hz

(reduced blanking)

Maximum resolution over VGA (through DVI to VGA cable): 2048 × 153

× 32 bpp at 85 Hz

Shading Architecture

**Supported Graphics** 

**APIs** 

Shader Model 5.0 DX11, OpenGL 4.2

Available Graphics

Drivers

Memory

Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers

are available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

NVIDIA Quadro 600 1GB Graphics Card

**Form Factor** 2.731" H x 6.6" L

Single Slot

Small Form Factor

Graphics Controller NVIDIA Quadro 600 Graphics Card

Bus Type PCI Express 2.0 x16

1 GB GDDR3

128-bit

**Connectors** 1 DVI-I output, 1DisplayPort output

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI adapters

available as accessories

Maximum Resolution DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz)

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

**Shading Architecture** Shader Model 5.0



Technical Specifications - Graphics

**Supported Graphics** 

**APIs** 

OpenGL 4.0 DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

**Available Graphics** 

**Drivers** 

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 3:

bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption 40 Watts

AMD FirePro V3900 1GB Graphics Card Form Factor

Full height, half length (full-height bracket included)

**Graphics Controller** 

AMD FirePro™ V3900 professional graphics

**Bus Type** 

PCI Express® x16, Generation 2.1

Memory

1GB DDR3 memory
1 DL DVI, 1 DP output

Connectors

One DP to DVI adapter included

**Maximum Resolution** 

2560x1600 per display (5120x1600 max. horizontal resolution)

**Display Output** 

1 DisplayPort® 1.2

1 Dual-link DVI

**Supported Graphics** 

**APIs** 

OpenCL™ 1.1, DirectX® 11 and OpenGL 4.2

Available Graphics

**Drivers** 

Genuine Windows® 7 Professional (64-bit and 32-bit) Genuine Windows Vista® Business (64-bit and 32-bit) Microsoft® Windows XP® Professional (64-bit and 32-bit)

Linux®\* (32-bit or 64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

**Power Consumption** 

Note

UM

AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connecte and/or certified DisplayPort™ active or passive adapters to convert you monitor's native input to your card's DisplayPort™ or Mini-DisplayPort¹ connector(s) may be required. See www.amd.com/firepro for details.

### Technical Specifications - Graphics

AMD FirePro V4900 1GB Graphics Card Form Factor Full height (4.37 in), half length (6.61 in)

Graphics Controller AMD FirePro™ V4900 Professional Graphics

Bus Type PCI Express™ x16, Generation 2.1

Memory 1GB GDDR5

Connectors 2 DisplayPort, 1 dual link DVI Output, One DP to DVI adapter included

**Maximum Resolution** Up to three digital displays at resolutions up to 2560 x 1600 @ 60Hz o up to three analog displays, one at resolutions up to 2048 x 1536 @

85Hz, plus two resolutions up to 1920 x 1200 @ 60Hz (165 MHz dot clock) Note: This card supports up to three displays with Windows 7,

Vista or Linux, and up to two displays on XP

**RAMDAC** 

Image Quality Features Up to 3 independent outputs with ATI Eyefinity technology support

(More information at:

www.amd.com/us/products/technologies/eyefinity/). Full 30-bit display pipeline. Advanced video capabilities, including high fidelity gamma, color correction and scaling. Dedicated hardware (UVD2) for H.264, VC

1, and MPEG2 decode

**NOTE:** The use of more than two displays on Linux requires support fo

xrandr 1.2 or greater in the X server.

**Supported graphics** 

**APIs** 

DirectX 11 and OpenGL 4.1.

OpenCL 1.2 DirectCompute 11

Available graphics

drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Linux®2 (32-bit or 64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site.

**Power Consumption** 

Note

<75W

1. AMD Eyefinity technology can support multiple displays using a sin enabled AMD FirePro<sup>™</sup> professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort<sup>™</sup> connecte and/or certified DisplayPort<sup>™</sup> active or passive adapters to convert you monitor's native input to your card's DisplayPort<sup>™</sup> or Mini-DisplayPort<sup>™</sup> connector(s) may be required. See www.amd.com/firepro for details. 2. Linux® drivers can be downloaded from support.amd.com



#### Technical Specifications - Graphics

NVIDIA Quadro 2000 1GB Graphics Card **Form Factor** 4.376" H x 7" L

Single Slot

**Graphics Controller** 

NVIDIA Quadro 2000 Graphics Card

**Bus Type** 

PCI Express 2.0 x16

Memory 1 GB GDDR5

128-bit

**Connectors** 1 DVI-I output, 2 DisplayPort outputs

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI adapters

available as accessories

Maximum Resolution Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120H:

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

**Image Quality Features** 

Up to 16K x16K texture and render processing

Transparent multisampling and super sampling

• 16x angle independent anisotropic filtering

• 128-bit floating point performance

• 32-bit per-component floating point texture filtering and blending

Support for any combination of two connected displays

• DisplayPort 1.1a, HDMI 1.3a, and HDCP support

NVIDIA® 3D Vision™ technology, 3D DLP, Interleaved, and othe

3D stereo format support

Full OpenGL quad buffered stereo support

Underscan/overscan compensation and hardware scaling

NVIDIA® nView® multi-display technology

**Shading Architecture** 

**Supported Graphics** 

**APIs** 

Shader Model 5.0

OpenGL 4.0 DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

**Available Graphics** 

**Drivers** 

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 3)

bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

**Power Consumption** 

62 Watts



### Technical Specifications - Graphics

AMD FirePro V5900 2GB Graphics Card

Form Factor Full-height, full length, single slot

Graphics Controller AMD FirePro™ V5900 Professional Graphics

Bus Type PCI Express™ x16, Generation 2.1

Memory 2GB GDDR5

**Connectors** 2 x Display Port 1.2 1 x Dual-link DVI

One DP to DVI adapter included with card

Maximum Resolution 2560 x 1600

**Display Output** Up to 3 simultaneous displays (using AMD Eyefinity with Windows 7 c

Linux)

Shading Architecture Shader Model 5.0

**Supported Graphics** 

**APIs** 

DirectX 11 and OpenGL 4.1

Available Graphics

**Drivers** 

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

**Power Consumption** 

Note

< 75W

AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro<sup>™</sup> professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort<sup>™</sup> connectc and/or certified DisplayPort<sup>™</sup> active or passive adapters to convert you monitor's native input to your card's DisplayPort<sup>™</sup> or Mini-DisplayPort<sup>™</sup> connector(s) may be required. See www.amd.com/firepro for details.

AMD FirePro V7900 2GB Graphics Card

Form Factor Full height, full length, single slot

Graphics Controller AMD FirePro™ V7900 Professional Graphics

Bus Type PCI Express™ x16, Generation 2.1

Memory 2GB GDDR5
Connectors 4 x DisplayPort 1.2

Two DP to DVI adapters included with card

Maximum Resolution 2560 x1600

**Display Output** Up to 4 simultaneous displays (using AMD Eyefinity with Windows 7 c

Linux)

**Shading Architecture** 

Supported Graphics DirectX

APIs

DirectX 11 and OpenGL 4.1

Shader Model 5.0

**Available Graphics** 

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Power Consumption < 150W



#### Technical Specifications - Graphics

Note

AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connectc and/or certified DisplayPort™ active or passive adapters to convert you monitor's native input to your card's DisplayPort™ or Mini-DisplayPort¹ connector(s) may be required. See www.amd.com/firepro for details.

NVIDIA Quadro 4000 2GB Graphics Card **Form Factor** 4.376" H x 9.50" L

Single Slot

**Graphics Controller** 

NVIDIA Quadro 4000 Graphics Card

Bus Type

PCI Express 2.0 x16

Memory 2 GB GDDR5

256-bit

**Connectors** 1 DVI-I output, 2 DisplayPort outputs;

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI (single-link of

dual-link) adapters available as accessories (Optional stereo bracket available from 3rd party)

**Maximum Resolution** 

Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120H: Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

RAMDAC 400 MHz integrated RAMDAC

**Image Quality Features** 

- Up to 16K x16K texture and render processing
- Transparent multisampling and super sampling
- 16x angle independent anisotropic filtering
- 128-bit floating point performance
- 32-bit per-component floating point texture filtering and blending
- Support for any combination of two connected displays
- DisplayPort 1.1a, HDMI 1.3a, and HDCP support
- NVIDIA 3D Vision™ technology, 3D DLP, Interleaved, and other 3D stereo format support
- Full OpenGL quad buffered stereo support
- Underscan/overscan compensation and hardware scaling
- NVIDIA nView® multi-display technology

**Shading Architecture** 

**Supported Graphics** 

**APIs** 

Shader Model 5.0 OpenGL 4.0

DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

**Drivers** 

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 3:

hit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:



Technical Specifications - Graphics

ftp://download.nvidia.com/novell or http://www.nvidia.com

142 Watts **Power Consumption** 

**NVIDIA Quadro 5000** 2.5GB Graphics Card **Form Factor** 4.376" H x 9.75" L

**Dual Slot** 

**Graphics Controller** 

NVIDIA Quadro 5000 Graphics Card

**Bus Type** Memory

PCI Express 2.0 x16

2.5 GB GDDR5

320-bit

**Connectors** DVI-I (1), DP (2), Stereo (1)

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI adapters

available as accessories

**Maximum Resolution** Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120H;

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

**Image Quality Features** 

Up to 16K x16K texture and render processing

Transparent multisampling and super sampling

16x angle independent anisotropic filtering

128-bit floating point performance

• 32-bit per-component floating point texture filtering and blending

Support for any combination of two connected displays

• DisplayPort 1.1a, HDMI 1.3a, and HDCP support

NVIDIA 3D Vision™ technology, 3D DLP, Interleaved, and other

3D stereo format support

Full OpenGL quad buffered stereo support

Underscan/overscan compensation and hardware scaling

NVIDIA nView® multi-display technology

**Shading Architecture** 

Supported Graphics

**APIs** 

Shader Model 5.0

OpenGL 4.0 DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

**Available Graphics** 

**Drivers** 

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 3:

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

**Power Consumption** 152 Watts



### Technical Specifications - Graphics

**NVIDIA Quadro 6000 6GB Graphics Card** 

**Form Factor** 4.376" H x 9.75" L

**Dual Slot** 

**Graphics Controller** 

NVIDIA Quadro 6000 Graphics Card

**Bus Type** 

PCI Express 2.0 x16

Memory

6 GB GDDR5

384-bit

**ECC Memory** 

Connectors

1 DVI-I output, 2 DisplayPort outputs, 1 Stereo(3-pin mini DIN);

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to dual link DVI

adapters available as accessories

Maximum Resolution

Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120H; Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

**Image Quality Features** 

• 30-bit color

Up to 16K x16K texture and render processing

Transparent multisampling and super sampling

• 16x angle independent anisotropic filtering

• 128-bit floating point performance

• 32-bit per-component floating point texture filtering and blending

• 64x full scene antialiasing (FSAA) / 128x FSAA in SLI Mode

Support for any combination of two connected displays

• DisplayPort 1.1a, HDMI 1.3a, and HDCP support

NVIDIA 3D Vision™ technology, 3D DLP, Interleaved, and other

3D stereo format support

Full OpenGL quad buffered stereo support

Underscan/overscan compensation and hardware scaling

NVIDIA nView® multi-display technology

**Shading Architecture** 

Supported Graphics

**APIs** 

Shader Model 5.0

OpenGL 4.0 DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

**Drivers** 

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 3:

bit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

**Power Consumption** <250 Watts



### Technical Specifications - High Performance GPU Computing

NVIDIA Tesla C2075 Compute Processor **Form Factor** 4.376 inches by 9.75 inches

**Dual Slot** 

System Interface PCI Express Gen2 ×16
Video Outputs One Dual Link DVI-I

(Entry graphics level of performance)

Memory 6GB GDDR5
Peak Memory +170 GB/s
Bandwidth

Supported APIs CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Supported Operating

**Systems** 

Genuine Windows 7 Professional (64-bit) Genuine Windows Vista Business (64-bit) Microsoft Windows XP Professional (64-bit)

Red Hat Enterprise Linux (RHEL) 5, 6 Desktop/Workstation (64-bit)

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

Processor Cores 448 CUDA cores
Power Consumption ~215 Watts

NOTE 1: A 1110W PSU is required for Tesla C2075 on the Z800 NOTE 2: A 600W PSU is required for Tesla C2075 on the Z400 NOTE 3: A 1125W PSU is required for Tesla C2075 on the Z820



Technical Specifications - Multimedia and Audio Devices

HP Thin USB Powered Frequency Response (- FO to 20kHz

**Speakers** 3dB, 24-bit/96kHz input)

**Dimensions** Speakers: 14.52 x 9.50 x 2.45 cm (5.72 x 3.74 x 0.96 in) per speaker



### Technical Specifications - Optical and Removable Storage

**HP DVD-ROM Drive** Description 5.25-inch, half-height, tray-load

**Mounting Orientation** Either horizontal or vertical

**Interface Type** SATA/ATAPI

**Dimensions** (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

**Disc Capacity DVD-ROM** Single layer: Up to 4.7 GB Double layer: Up

8.5 GB

**Access Times DVD-ROM Single Layer < 140 ms (typical)** 

> **CD-ROM Mode 1** < 125 ms (typical) **Full Stroke DVD** < 250 ms (seek) **Full Stroke CD** < 210 ms (seek)

Power Source SATA DC power receptacle

> **DC Power** 5 VDC ± 5%-100 mV ripple p-p Requirements 12 VDC ± 5%-200 mV ripple p-p

**DC Current** 5 VDC - <1000 mA typical, < 1600 mA

maximum

12 VDC - < 600 mA typical, < 1400 mA

5° to 50° C (41° to 122° F)

maximum

10% to 90%

30° C (86° F)

Operating

Environmental (all conditions noncondensing)

**Temperature** 

**Relative Humidity Maximum Wet Bulb** 

**Temperature** 

**Operating Systems** 

Supported

Windows 7 Professional 32-bit and 64-bit,

Windows Vista Business 64\*. Windows Vist Business 32\*, Windows Vista Home Basic

32\*, Windows 2000, Windows XP Professional or Windows XP Home 32\*. Red Hat Enterprise Linux(RHEL) WS4\*\*, 5, 6

Desktop/Workstation,

Removed reference to "Novell" because of acquisition and changed product reference to "SUSE Linux Enterprise Desktop 10 & 11", No driver is required for this device. Native support is provided by the operating system.

HP DVD+/-RW Drive

Description 5.25-inch, half-height, tray-load

**Mounting Orientation** Either horizontal or vertical

Interface Type SATA/ATAPI

**Dimensions** (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

**Disc Formats DVD-RAM** 

DVD+R **DVD+RW** DVD+R DL DVD-R DL DVD-R **DVD-RW** CD-R CD-RW

**Disc Capacity DVD-ROM** 8.5 GB DL or 4.7 GB standard

> **Full Stroke DVD** < 250 ms (seek) **Full Stroke CD** < 210 ms (seek)



Technical Specifications - Optical and Removable Storage

Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up to 40X CD-RW Up to 32X	
	DVD ROM Read	DVD-RAM	Up to 12X
		DVD+RW	Up to 8X
		DVD-RW	Up to 8X
		DVD+R DL	Up to 8X
		DVD-R DL	Up to 8X
		DVD-ROM	Up to 16X
		DVD-ROM DL	Up to 8X
		DVD+R	Up to 16X
		DVD-R	Up to 16X
Power	Source	SATA DC power receptacle	
	DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 5%-200 mV ripple p-p	
	DC Current	5 VDC -1000 mA typical, 1600 mA maximur 12 VDC -600 mA typical, 1400 mA maximur	
Operating Environmental (all conditions non- condensing)	Temperature	5° to 50° C (41° to 122° F)	
	<b>Relative Humidity</b>	10% to 90%	
	Maximum Wet Bulb Temperature	30° C (86° F)	
	Operating Systems Supported	Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation SUSE Linux Enterprise Desktop 10 & 11	
	Kit Contents	No driver is required for this device. Native support is provided by the operating system. HP SATA SuperMulti DVD Writer Drive, Rox Easy Media Creator software, Intervideo WinDVD Software, installation guide, and DVD+R media.	

**HP Blu-Ray Writer** 

Description5.25-inch, half-height, tray-loadMounting OrientationEither horizontal or vertical

Interface Type SATA

**Dimensions** (WxHxD)  $15.0 \times 4.4 \times 20.3 \text{ cm} (5.9 \times 1.7 \times 8.0 \text{ in})$ 

Disc Formats

BD-ROM

BD-R

BD-RE

DVD-RAM

DVD+R

DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW



Technical Specifications - Optical and Removable Storage

Disc Capacity	DVD-ROM Blu-ray Full Stroke DVD Full Stroke CD Blu-ray	8.5 GB DL or 4.7 GB standard 50 GB DL or 25 GB standard < 250 ms (seek) < 210 ms (seek) Blu-ray	
	Startup Time (Time to drive ready from tray loading)	BD-ROM (SL/DL) BD-R (SL/DL) BD-RE (SL/DL) DVD-ROM (SL/DL) DVD-R (SL/DL) DVD-RW DVD+R (SL/DL) DVD+RW DVD+RW	25S / 28S 25S / 28S 25S / 28S 18S / 18S 25S / 25S 25S / 25S 25S / 25S 25S
Maximum Data Transfer Rates	CD ROM Read	CD-ROM CD-ROM CD-R CD-RW	45S Up to 40X Up to 40X Up to 40X
	DVD ROM Read	DVD-RAM DVD+RW DVD-RW DVD+R DL DVD-R DL DVD-ROM DVD-ROM DL DVD+R BVD-R BD-ROM BD-ROM DL BD-R BD-R BD-R BD-R BD-R BD-R BD-R BD-R	Up to 5X Up to 10X Up to 10X Up to 8X Up to 8X Up to 16X Up to 8X Up to 12X Up to 12X Up to 6X Up to 4.8X
Power	Source DC Power Requirements DC Current	SATA DC power receptacle  5 VDC ± 5%-100 mV ripple p-p  12 VDC ± 10%-100 mV ripple p-p  5 VDC -900 mA typical, 1200 mA maximum  12 VDC -1000 mA typical, 1600 mA maximu	
Operating Environmental (all conditions non- condensing)	Temperature Relative Humidity Maximum Wet Bulb Temperature Operating Systems Supported	5° to 50° C (41° to 122° F) 15% to 80% 30° C (86° F)  Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vist Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*.	



Red Hat Enterprise Linux(RHEL) WS4\*\*, 5, (

Desktop/Workstation,

### Technical Specifications - Optical and Removable Storage

SUSE Linux Enterprise Desktop 10 & 11

\* No driver is required for this device. Native support is provided by the operating system.

\*\* RHEL WS4 not supported on

Z200/Z200SFF

Kit Contents HP Blue Laser RW Drive, Roxio Easy Media

Creator software, Intervideo WinDVD

Software, installation guide.

**Disclaimer** As Blu-Ray is a new format containing new technologies, certain disc,

digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-Ray titles to play, the may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this

workstation.

HP 22-in-1 Media Card Description

Reader

The Media Card Reader device uses the same physical form factor and mounting as a Floppy Disk Drive. The device connects to a 2x5 two-channel USB header on the motherboard of the system. There is no

USB controller card provided. Please see the Disc Formats section below for a list of flash memory card formats that are supported.

**Mounting Orientation** The Media Card Reader can be mounted in a dedicated Floppy Drive

bay (if the chassis provides one) or in an appropriate Optical Bay

adapter. It will operate in any orientation.

Interface Type USB 2.0 (one channel dedicated to the separate USB port; one channel

dedicated to the flash memory card slots)

**Dimensions** (WxHxD) 124.5 x 101.6 x 25.4 mm (4.9 x 4.0 x 1.0 in)

**Disc Formats** xD-Picture

Micro SD Micro SDHC

SD

SDHC SDXC Mini SD Mini SDHC

MultiMediaCard (MMC)

Reduced Size MultiMediaCard (RS MMC)

MultiMedia Card 4.2 (MMC Plus, including MMC Plus HC)

Reduced Size MultiMedia Card 4.2 (MMC Mobile, including MMC Mob

HC)

CompactFlash Card Type I CompactFlash Card Type II

MicroDrive

Memory Stick (MS)

MagicGate Memory Stick (MG) MagicGate Memory Stick Duo

Memory Stick Select

Memory Stick Duo (MS Duo) Memory Stick PRO (MS PRO)

Memory Stick PRO Duo (MS PRO Duo)

Memory Stick PRO-HG Duo

Two additional formats are usable with adapters (not supplied):

MMC Micro



Technical Specifications - Optical and Removable Storage

Memory Stick Micro (M2)



### Technical Specifications - Controller Cards

**HP IEEE 1394b** FireWire PCIe Card **Data Transfer Rate** Supports up to 800 Mbps **Devices Supported** IEEE-1394 compliant devices **Bus Type** PCIe card full height PCIe slots

**Ports** Two IEEE-1394b bilingual 9-Pin Connector (Rear)

**Internal Connectors** One 10-Pin header Custom Connector

System Requirements Windows 7 Professional 32-bit and 64-bit, Microsoft® Windows® XP

Professional, Windows XP Home, Windows Vista. Not supported on Linux. Pentium® III or higher processor 128-MB RAM 1-GB Hard Drive

CD-ROM drive Built in sound system Available PCI slot

Temperature -Operating

50° to 131° F (10° to 55° C)

Temperature – Storage –22° to 140° F (–30° to 60° C)

Relative Humidity -

Operating

20% to 80%

Compliances FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-

1998 STD, Taiwan BSMI CNS13438, Korea MIC

**Operating Systems** 

Supported

Windows 7 Professional 32-bit and 64-bit, Windows Vista® Business 32-bit and 64-bit, Windows® XP Professional, XP Professional 64-bit.

Not supported on Linux.



### Technical Specifications - Networking and Communications

Integrated Intel 82579LM PCIe GbE Controller Connector RJ-45

Controller Intel 82579LM GbE platform LAN connect networking controller

Memory 24 KB FIFO packet buffer memory

Data Rates Supported 10/100/1000 Mbps

Compliance 802.1P, 802.1Q, 802.2, 802.3, 802.3ab, 802.3az, 802.3u

Bus Architecture PCI Express and SMBus

**Data Transfer Mode** PCIe-based interface for active state operation (S0 state) and SMBus

for host and management traffic (Sx low power state)

Power Requirement Requires 3.3V and 1.05V or just 3.3V with integrated regulators

**Boot ROM Support** Yes

Network Transfer Mode Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities

WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced

cable diagnostic.

AMT 7.0 support

Intel Gigabit CT Desktop NIC

Connector RJ-45

Controller Intel WG82574L Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant,

802.3x flow control

Bus Architecture PCI-E 1.0a

**Data Path Width** X1, 250 MB/s, Bi-directional interface

Data Transfer Mode Bus-master DMA

Hardware FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS

**Certifications** Mark for European Union

Power Requirement Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

Boot ROM Support Yes

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature32° to 131°F (0° to 55° C)
Operating Humidity 85% at 131° F (55° C)

**Dimensions** 12.1 x 5.7 x 2.0 cm (4.75 x 2.25 x 0.8 in)

Operating System Driver Support Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64 Windows Vista Business 32, Windows XP Professional, Windows XP

x64.

Red Hat Enterprise Linux 4 (RHEL4.8 or newer)\*, Red Hat Enterprise

Linux 5 (RHEL5.3 or newer), Red Hat Enterprise Linux 6

\* RHEL WS4 not supported on Z200/Z200SFF

Management Capabilities

WOL, PXE, DMI, WFM 2.0



#### Technical Specifications - Networking and Communications

**Kit Contents** Intel Gigabit CT Desktop NIC, low profile bracket, CD containing Intel

PROset II NIC drivers, quick install quide, product warranty statement

Broadcom (5761) NetXtreme Gigabit Ethernet Plus NIC Connector RJ-45

Controller Broadcom 5761 PCI-Express LAN Controller

Memory 8 MB NVRAM serial Flash

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB, 802.3u, and 802.3x

Bus Architecture PCI-Express

Data Path Width Single Channel PCI-Express

Data Transfer Mode Bus Master DMA

**Hardware** FCC class B, Canada and US NRTL Mark, C-Tick for Australia, BSMI **Certifications** for Taiwan, VCCI for Japan, MIC for Korea, GOST for Russia, UL listed

(E212044), European Union Notice (CE 0682)

Power Requirement 1.8W @ 3.3V

**Boot ROM Support** Yes

Network Transfer Mode Full-duplex

Half-duplex (not available for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature32° to 131°F (0° to 55° C)

**Operating Humidity** 131° F (55° C) with 5% to 95% non-condensing humidity **Dimensions** 7 cm x 10.5 cm (2.75 in x 4.13 in), low profile compatible

Operating System Driver Support

Windows 7 Professional 32-bit and 64-bit, Windows Vista 32-bit SP1, Windows Vista x64 SP1, Windows XP 32 bit professional, Windows XI

X64

Red Hat Enterprise Linux(RHEL) WS4\*, 5, 6 Desktop/Workstation

Novell SLED 10 & 11

\*RHEL WS4 not supported on Z200/Z200SFF

Management Capabilities Kit Contents ACPI, WOL and DMI 2.0, PXE 2.0, WfM 2.0, Broadcom mgmt utility,

ASF2.0, DASH 1.0 and DASH 1.1 profiles

Broadcom NetXtreme Gigabit Ethernet Plus NIC, Broadcom NetXtreme

Gigabit Ethernet Plus NIC USB Cable Assembly, CD, drivers, quick

install guide, product warranty statement



#### Technical Specifications - Networking and Communications

HP NC360T PCI Express Dual Port Gigabit NIC ConnectorTwo RJ-45ControllerIntel 82571EBMemoryIntegrated 96KBData Rates Supported10/100/1000 Mbps

**Compliance** 802.3, 802.3u, 802.3x, 802.3ab, 802.3ad, 802.1p, 802.1Q

Bus Architecture PCI-E 1.0a

**Data Path Width** Four lane (x4) PCI Express compatible with x4, x8, and x16 PCI

Express slots

Data Transfer Mode Bus-master DMA

**Hardware** FCC Class B, VCCI Class B, BSMI Class A, CISPR 22 Class B, EN **Certifications** 55022 Class B, EN55024-1, ICES-003 Class B, MIC Class B, ACA

Class B, UL, Canada UL, EN60950

Power Requirement 1280 mA @ 3.3V typical

**Boot ROM Support** Yes

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature32° to 131°F (0° to 55° C)

Operating Humidity 0% to 95% non-condensing

Dimensions 12.95 x 6.8 cm (5.1 x 2.7 in)

Operating System W Driver Support P

Windows Vista Business 64, Windows Vista Business 32, Windows X

Professional, Windows XP Professional x64 Edition.

Red Hat Enterprise Linux(RHEL) WS4, 5, 6 Desktop/Workstation

Novell SLED 10 & SLED 11

Management Capabilities

WOL, PXE 2.1

Kit Contents HP NC360T PCI Express Dual Port Gigabit NIC, low profile bracket, CI

containing Intel PROset II NIC drivers, quick install guide, product

warranty statement

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